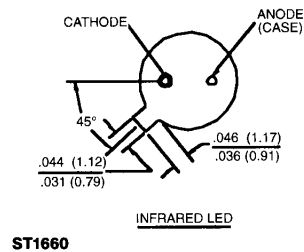
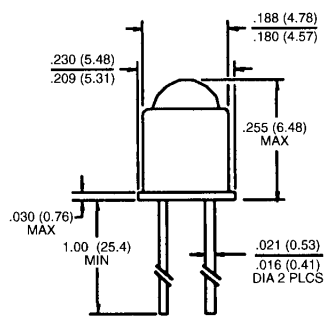
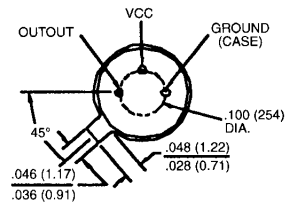
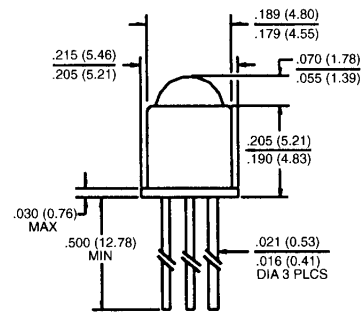


**PACKAGE DIMENSIONS**



**ST1660**



**ST1661**

**NOTES:**

1. DIMENSIONS ARE IN INCHES [mm].
2. TOLERANCE IS  $\pm .010$  [.25] UNLESS OTHERWISE SPECIFIED.

**DESCRIPTION**

The QPA8259 consists of an 880nm AlGaAs LED and an OPTOLOGIC™ silicon photosensor mounted in hermetically sealed packages.

**FEATURE**

- Narrow emission/reception angle
- Hermetically sealed packages

**ABSOLUTE MAXIMUM RATINGS** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Specified)

Storage Temperature .....	$-65^\circ\text{C}$ to $+150^\circ\text{C}$
Operating Temperature .....	$-65^\circ\text{C}$ to $+125^\circ\text{C}$
Soldering:	
Lead Temperature (Iron) .....	$240^\circ\text{C}$ for 5 sec. <sup>(3,4,5)</sup>
Lead Temperature (Flow) .....	$260^\circ\text{C}$ for 10 sec. <sup>(3,4)</sup>

**INPUT DIODE**

Continuous Forward Current .....	60 mA
Reverse Voltage .....	3.0 Volts
Power Dissipation .....	170 mW <sup>(1)</sup>

**OUTPUT OPTOLOGIC™**

Output Current .....	50 mA
Operation Voltage Allowed Range .....	4.5 to 16 Volts
Output Voltage Allowed Range .....	4.5 to 16 Volts
Power Dissipation .....	250 mW <sup>(2)</sup>

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Specified)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
<b>INPUT DIODE</b>						
Forward Voltage	$V_F$	—		1.7	V	$I_F = 20\text{ mA}$
Reverse Leakage Current	$I_R$	—		10	$\mu\text{A}$	$V_R = 3\text{ V}$
<b>OUTPUT OPTOLOGIC™</b>						
Operating Supply Voltage	$V_{CC}$	4.5		16.0	V	
Supply Current	$I_{CC}$	—		12.0	mA	$E_e = 0$ or $0.3\text{ mW/cm}^2$
Output Current High	$I_{OH}$	—		10	$\mu\text{A}$	$E_e = 0$ , $V_{OH} = 30\text{ V}$
Low Level Output Voltage	$V_{OL}$	—		0.4	V	$E_e = .3\text{ mW/cm}^2$ , $R_L = 270\Omega$
<b>COUPLED</b>						
Turn-On Threshold Current	$I_{F(+)}$	—		20.0	mA	$V_{CC} = 5\text{ V}$ , $R_L = 270\Omega$ , $D = .250$ <sup>(6)</sup>
Turn-Off Threshold Current	$I_{F(-)}$	1.0		—	mA	$V_{CC} = 5\text{ V}$ , $R_L = 270\Omega$ , $D = .250$ <sup>(6)</sup>
Hysteresis Ratio	$I_{F(+)} / I_{F(-)}$	1.1		2.0		$V_{CC} = 5\text{ V}$ , $R_L = 270\Omega$ , $D = .250$ <sup>(6)</sup>

**NOTES**

1. Derate power dissipation linearly  $1.70\text{ mW}/^\circ\text{C}$  above  $25^\circ\text{C}$ .
2. Derate power dissipation linearly  $2.50\text{ mW}/^\circ\text{C}$  above  $25^\circ\text{C}$ .
3. RMA flux is recommended.
4. Methanol or Isopropyl alcohols are recommended as cleaning agents.
5. Soldering iron tip  $1/16"$  (1.6 mm) from housing.
6. D is the distance from lens tip to lens tip.

**DISCLAIMER**

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

**LIFE SUPPORT POLICY**

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.